

**Features**

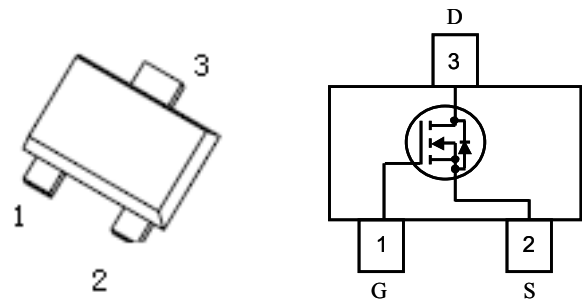
- Lead Free Product is Acquired
- Surface Mount Package
- N-Channel Switch with Low  $R_{DS(on)}$
- Operated at Low Logic Level Gate Drive

**Product Summary**

BVDSS	RDSON (TYP.)	ID (MAX)
20V	240mΩ	0.6A
20V	280mΩ	
20V	410mΩ	
20V	450mΩ	

**Applications**

- Load/Power Switching
- Interfacing Switching
- Battery Management for Ultra Small Portable Electronics
- Logic Level Shift

**SOT-723 Pin Configuration**

**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	20	V
$V_{GS}$	Gate-Source Voltage	$\pm 8$	V
$I_D@T_A=25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	400	mA
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	1.2	A
$P_D@T_A=25^\circ C$	Total Power Dissipation <sup>3</sup>	0.150	W
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient (note 1)	823	$^\circ C/W$
$T_J$	Junction Temperature	150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_L$	Lead Temperature for Soldering Purposes(1/8" from case for 10 s)	260	$^\circ C$

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	20	---	---	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA	---	0.05	---	V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.4A	---	240	450	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =0.3A	---	280	765	
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =0.2A	---	410	850	mΩ
		V <sub>GS</sub> =1.5V, I <sub>D</sub> =0.1A	---	450	950	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	0.35	---	1.0	V
ΔV <sub>GS(th)</sub>	V <sub>GS(th)</sub> Temperature Coefficient		---	-3.7	---	mV/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	---	---	1	uA
		V <sub>DS</sub> =16V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C	---	---	5	
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V	---	---	±10	uA
gfs	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =0.1A	---	1.5	---	S
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =15V, V <sub>GS</sub> =10V, R <sub>G</sub> =6Ω, I <sub>D</sub> =0.1A	---	5.8	---	ns
T <sub>r</sub>	Rise Time		---	2.9	---	
T <sub>d(off)</sub>	Turn-Off Delay Time		---	18	---	
T <sub>f</sub>	Fall Time		---	9	---	
C <sub>iSS</sub>	Input Capacitance	V <sub>DS</sub> =15V, V <sub>GS</sub> =0V, f=1MHz	---	88	---	pF
C <sub>oSS</sub>	Output Capacitance		---	15	---	
C <sub>rSS</sub>	Reverse Transfer Capacitance		---	10	---	

**Diode Characteristics**

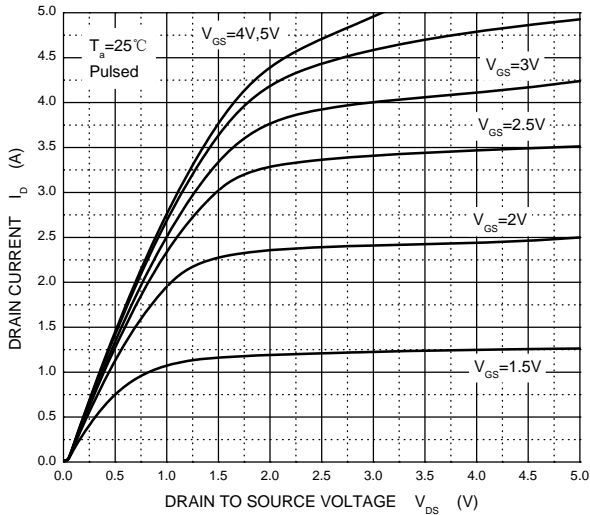
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current <sup>1,4</sup>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	100	mA
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>		---	---	0.5	A
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V, I <sub>S</sub> =0.2A, T <sub>J</sub> =25°C	---	---	1.2	V

**Notes :**

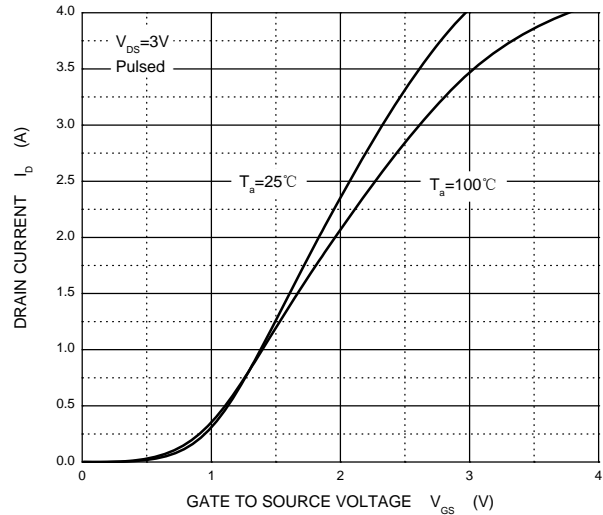
1. Surface mounted on FR4 board using the minimum recommended pad size.
2. Pulse Test : Pulse Width=300μs, Duty Cycle=2%.
3. Switching characteristics are independent of operating junction temperatures.
4. Guaranteed by design, not subject to producing.

Typical Performance Characteristics

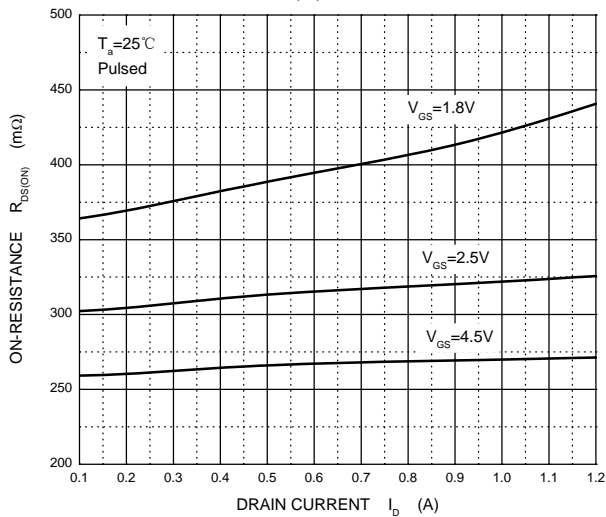
Output Characteristics



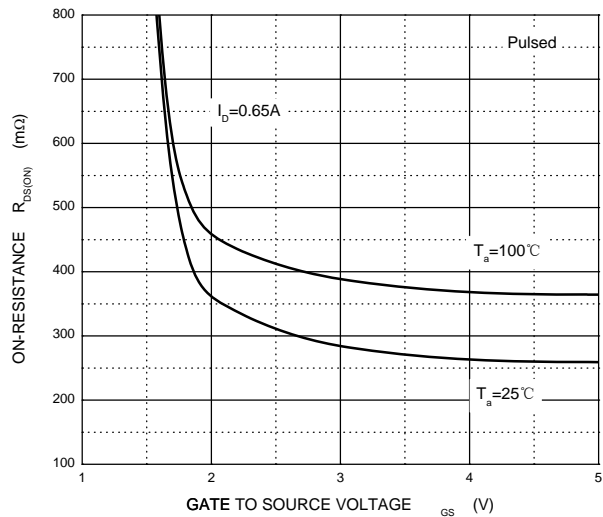
Transfer Characteristics



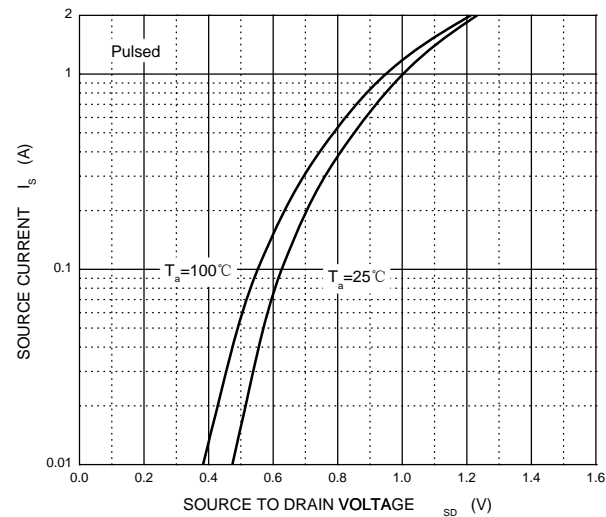
$R_{DS(ON)}$  —  $I_D$



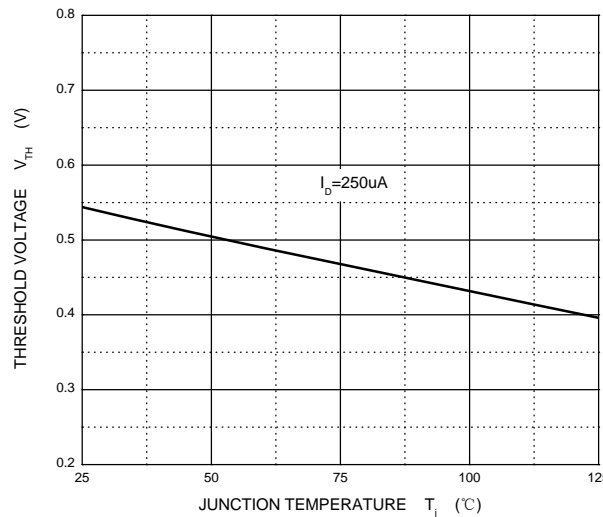
$R_{DS(ON)}$  —  $V_{GS}$



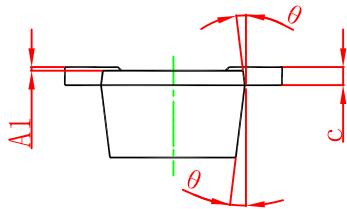
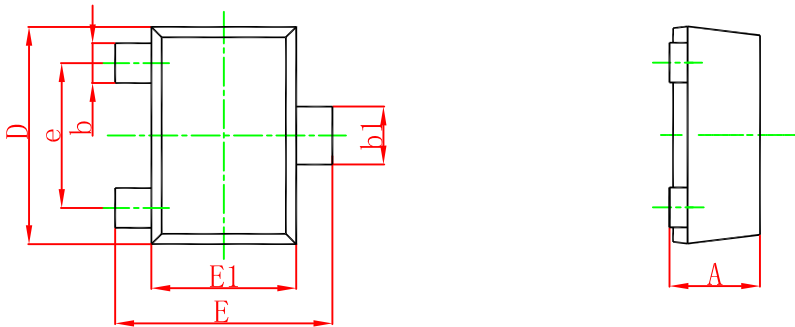
$I_S$  —  $V_{SD}$



Threshold Voltage

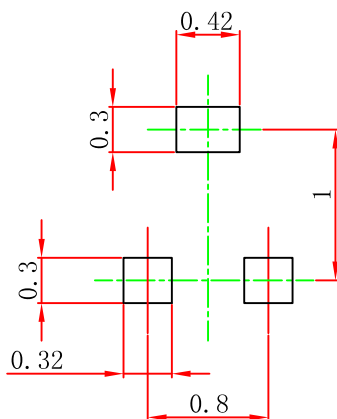


**SOT-723 Package Outline Dimensions**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.430	0.500	0.017	0.020
A1	0.000	0.050	0.000	0.002
b	0.170	0.270	0.007	0.011
b1	0.270	0.370	0.011	0.015
c	0.080	0.150	0.003	0.006
D	1.150	1.250	0.045	0.049
E	1.150	1.250	0.045	0.049
E1	0.750	0.850	0.030	0.033
e	0.800TYP.		0.031TYP.	
$\theta$	7° REF.		7° REF.	

**SOT-723 Suggested Pad Layout**



**Note:**

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$ mm.
3. The pad layout is for reference purposes only.

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